

Ultrafast Rectifier, 15 A FRED Pt®



| PRIMARY CHARACTERISTICS | | | | | | |
|----------------------------------|-------------------------------------|--|--|--|--|--|
| I _{F(AV)} | 15 A | | | | | |
| V _R | 600 V | | | | | |
| V _F at I _F | 1.1 V | | | | | |
| t _{rr} (typ.) | 24 ns | | | | | |
| T _J max. | 175 °C | | | | | |
| Package | D ² PAK 2L (TO-263AB 2L) | | | | | |
| Circuit configuration | Single | | | | | |

FEATURES

- Low forward voltage drop
- · Ultrafast recovery time
- 175 °C operating junction temperature

· Low leakage current



- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

State of the art, ultralow V_F, soft-switching ultrafast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

APPLICATIONS

AC/DC SMPS 70 W to 400 W

e.g. laptop and printer AC adapters, desktop PC, TV and monitor, games units, and DVD AC/DC power supplies.

MECHANICAL DATA

Case: D²PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating **Terminals:** matte tin plated leads, solderable per

J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
|---|-----------------------------------|-------------------------|-------------|-------|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | | | |
| Repetitive peak reverse voltage | V _{RRM} | | 600 | V | | | |
| Average rectified forward current | I _{F(AV)} | T _C = 143 °C | 15 | ۸ | | | |
| Non-repetitive peak surge current | I _{FSM} | T _C = 25 °C | 160 | А | | | |
| Operating junction and storage temperatures | T _J , T _{Stg} | | -55 to +175 | °C | | | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|--|--------------------|--|------|------|------|-------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | |
| Breakdown voltage, blocking voltage | V_{BR} , V_{R} | I _R = 100 μA | 600 | - | - | | | |
| Forward voltage | V | I _F = 15 A | - | 1.35 | 1.9 | V | | |
| | V _F | I _F = 15 A, T _J = 150 °C | - | 1.1 | 1.3 | | | |
| Develop legicage overwent | | V _R = V _R rated | - | 0.01 | 15 | μА | | |
| Reverse leakage current | I _R | T _J = 150 °C, V _R = V _R rated | - | 20 | 200 | | | |
| Junction capacitance | C _T | V _R = 600 V | - | 12 | - | pF | | |
| Series inductance | L _S | Measured lead to lead 5 mm from package body | - | 8.0 | - | nH | | |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|---|------------------|--|--|------|------|-------|------------|--|
| PARAMETER | SYMBOL | TEST CO | MIN. | TYP. | MAX. | UNITS | | |
| | | $I_F = 1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ | | - | | - | - | |
| Reverse recovery time | t _{rr} | T _J = 25 °C | T _J = 25 °C | - | 40 | - | ns | |
| | | T _J = 125 °C | | - | 87 | - | | |
| Deal area area | I _{RRM} | T _J = 25 °C | $I_F = 15 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_R = 390 \text{ V}$ | - | 5 | - | - A - С | |
| Peak recovery current | | T _J = 125 °C | | - | 9.0 | - | | |
| Devenue vegeven eberne | 0 | T _J = 25 °C | | - | 107 | - | | |
| Reverse recovery charge | Q _{rr} | T _J = 125 °C | | - | 430 | - | | |
| Reverse recovery time | t _{rr} | | I _F = 15 A dI _F /dt = 800 A/μs | - | 53 | - | ns | |
| Peak recovery current | I _{RRM} | T _J = 125 °C | | - | 25 | - | Α | |
| Reverse recovery charge | Q _{rr} | | V _R = 390 V | - | 730 | - | nC | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | |
|--|-----------------------------------|--|-----------|------|------------|------------------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | 175 | °C | |
| Thermal resistance, junction to case | R _{thJC} | | - | - | 1.51 | °C/W | |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | - | - | 70 | | |
| Thermal resistance, case to heat sink | R _{thCS} | Mounting surface, flat, smooth and greased | - | 0.5 | - | | |
| \\\ai~b+ | | | - | 2.0 | = | g | |
| Weight | | | - | 0.07 | = | OZ. | |
| Mounting torque | | | 6 (5) | - | 12 (10) | kgf · cm (lbf · in) | |
| Marking device | | Case style D ² PAK 2L (TO-263AB 2L) | ETU1506SH | | | | |

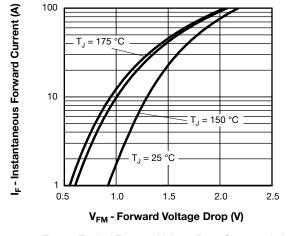


Fig. 1 - Typical Forward Voltage Drop Characteristics

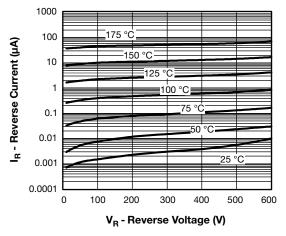


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

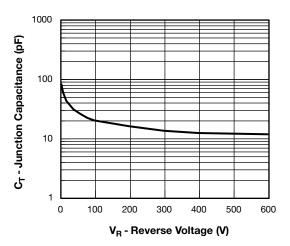


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

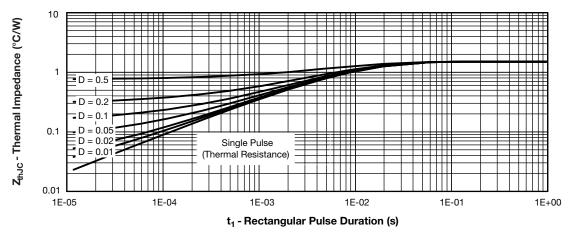


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics

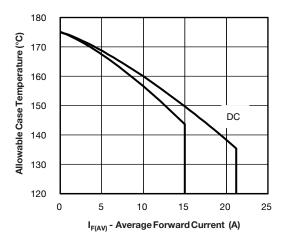


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

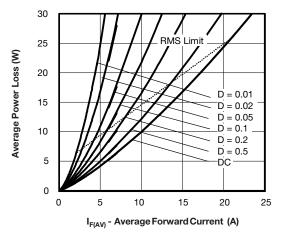


Fig. 6 - Forward Power Loss Characteristics

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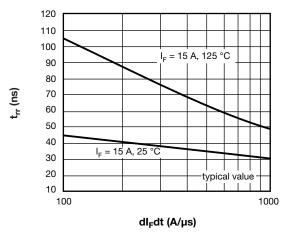


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

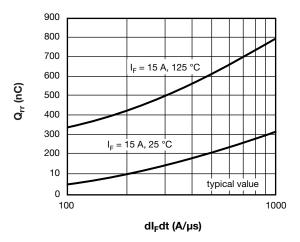
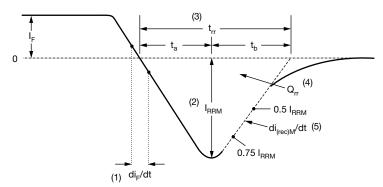


Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm I_F$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

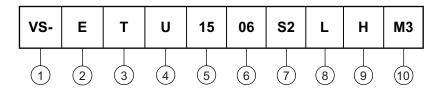
(5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

Circuit configuration
E = single diode

T = D²PAK (TO-262) package

- U = ultrafast recovery time

5 - Current code (15 = 15 A)

6 - Voltage code (06 = 600 V)

7 - S2 = true 2 pin D²PAK

None = tube (50 pieces)

L = tape and reel (left oriented, for D²PAK package)
 If needed different orientation/packaging, please contact factory

9 - H = AEC-Q101 qualified

- M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

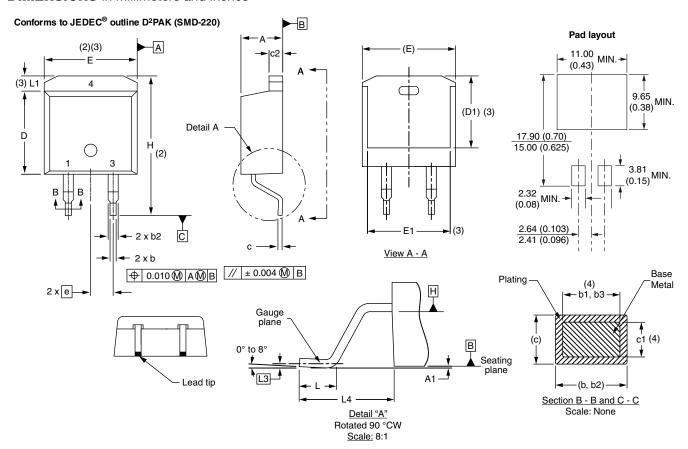
| ORDERING INFORMATION (Example) | | | | | | |
|---|-----|-------------------|--|--|--|--|
| PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION | | | | | | |
| VS-ETU1506S2LHM3 | 800 | 13" diameter reel | | | | |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?96683 | | | |
| Part marking information | www.vishay.com/doc?96693 | | | |
| Packaging information | www.vishay.com/doc?95032 | | | |
| SPICE model | www.vishay.com/doc?96132 | | | |



D²PAK 2L (TO-263AB 2L)

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIM | ETERS | INCHES | | NOTES |
|----------|--------|-------|--------|-------|-------|
| STIVIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.06 | 4.83 | 0.160 | 0.190 | |
| A1 | 0.00 | 0.254 | 0.000 | 0.010 | |
| b | 0.51 | 0.99 | 0.020 | 0.039 | |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| С | 0.38 | 0.74 | 0.015 | 0.029 | |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 |

| SYMBOL | MBOI MILLIMETERS INCHES | | NOTES | | |
|---------|-------------------------|-------|-----------|-------|-------|
| STWIBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| Е | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| е | 2.54 BSC | | 0.100 BSC | | |
| Н | 14.61 | 15.88 | 0.575 | 0.625 | |
| L | 1.78 | 2.79 | 0.070 | 0.110 | |
| L1 | - | 1.65 | - | 0.066 | 3 |
| L3 | 0.25 BSC | | 0.010 | BSC | |
| L4 | 4.78 | 5.28 | 0.188 | 0.208 | |
| | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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